



Product Change Notification

Change Notification #: 115266 - 00
Change Title: Select Intel® SSD DC D3600 Series and Intel® SSD DC D3700 Series Products, PCN 115266-00, Product Design, Firmware Update
Date of Publication: January 19, 2017

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	February 03, 2017
---	-------------------

Description of Change to the Customer:

The Intel® SSD DC D3600 Series and Intel® SSD DC D3700 Series firmware version is being updated from 8DV101D0 to 8DV101H0. The changes in the new firmware version are incremental improvements from previous version. Inventory will transition in the Intel factory on or beyond the above date to replace older firmware version with the latest version.

Customer Impact of Change and Recommended Action:

Since the firmware update has incremental improvement over the previous version, Intel anticipates no product impact with this firmware, and re-qualification is not recommended.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change SA	Post Change TA	Post Change SA
Intel® SSD DC D3600 Series (1.0TB, 2.5in PCIe 3.0 2x2, 20nm, MLC) Generic Single Pack	SSDPD2ME010T401	945557	H90647-200	H90655-200	H90647-201	H90655-201
Intel® SSD DC D3600 Series (2.0TB, 2.5in PCIe 3.0 2x2, 20nm, MLC) Generic Single Pack	SSDPD2ME020T401	945558	H90648-200	H90656-200	H90648-201	H90656-201
Intel® SSD DC D3700 Series (800GB, 2.5in PCIe 3.0 2x2, 20nm, MLC) Generic Single Pack	SSDPD2MD800G401	945559	H90649-200	H90657-200	H90649-201	H90657-201
Intel® SSD DC D3700 Series (1.6TB, 2.5in PCIe 3.0 2x2, 20nm, MLC) Generic Single Pack	SSDPD2MD016T401	945560	H90650-200	H90658-200	H90650-201	H90658-201

PCN Revision History:

Date of Revision: January 19, 2017	Revision Number: 00	Reason: Originally Published PCN
--	-------------------------------	--



Product Change Notification

115266 - 00

INFORMATION IN THIS DOCUMENT IS PROVIDED IN CONNECTION WITH INTEL PRODUCTS. NO LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT. EXCEPT AS PROVIDED IN INTEL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, INTEL ASSUMES NO LIABILITY WHATSOEVER AND INTEL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY, RELATING TO SALE AND/OR USE OF INTEL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

A "Mission Critical Application" is any application in which failure of the Intel Product could result, directly or indirectly, in personal injury or death. SHOULD YOU PURCHASE OR USE INTEL'S PRODUCTS FOR ANY SUCH MISSION CRITICAL APPLICATION, YOU SHALL INDEMNIFY AND HOLD INTEL AND ITS SUBSIDIARIES, SUBCONTRACTORS AND AFFILIATES, AND THE DIRECTORS, OFFICERS, AND EMPLOYEES OF EACH, HARMLESS AGAINST ALL CLAIMS COSTS, DAMAGES, AND EXPENSES AND REASONABLE ATTORNEYS' FEES ARISING OUT OF, DIRECTLY OR INDIRECTLY, ANY CLAIM OF PRODUCT LIABILITY, PERSONAL INJURY, OR DEATH ARISING IN ANY WAY OUT OF SUCH MISSION CRITICAL APPLICATION, WHETHER OR NOT INTEL OR ITS SUBCONTRACTOR WAS NEGLIGENT IN THE DESIGN, MANUFACTURE, OR WARNING OF THE INTEL PRODUCT OR ANY OF ITS PARTS.

Intel may make changes to specifications and product descriptions at any time, without notice. Designers must not rely on the absence or characteristics of any features or instructions marked "reserved" or "undefined". Intel reserves these for future definition and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to them. The information here is subject to change without notice. Do not finalize a design with this information.

The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

Copyright © Intel Corporation 2017. Other names and brands may be claimed as the property of others.

BunnyPeople, Celeron, Celeron Inside, Centrino, Centrino Inside, Cilk, Core Inside, i960, Intel, the Intel logo, Intel AppUp, Intel Atom, Intel Atom Inside, Intel Core, Intel Inside, Intel Insider, the Intel Inside logo, Intel NetBurst, Intel NetMerge, Intel NetStructure, Intel SingleDriver, Intel SpeedStep, Intel Sponsors of Tomorrow, the Intel Sponsors of Tomorrow logo, Intel StrataFlash, Intel vPro, Intel XScale, InTru, the InTru logo, the InTru Inside logo, InTru soundmark, Itanium, Itanium Inside, MCS, MMX, Moblin, Pentium, Pentium Inside, Puma, skool, the skool logo, Sound Mark, The Creators Project, The Journey Inside, Thunderbolt, vPro Inside, VTune, Xeon, and Xeon Inside are trademarks of Intel Corporation in the U.S. and/or other countries.

Learn how to use Intel Trademarks and Brands correctly at <http://www.intel.com/intel/legal/tmusage2.htm>.